

SPECIFICATIONS

Housing: Thermoplastic (UL94 V-0)

Terminal: Phosphor Bronze, Gold Plating On Contact Area, Tin Plating On Solder Tail.

Current Rating: 0.5A Max.

Dielectric Withstanding Voltage: 500V AC R.M.S. For 1 Minute

Insulation Resistance: 1000 Megohms Min. At DC 500V

Contact Resistance: 50 Milliohms Max.

Durability: 5000 Cycles

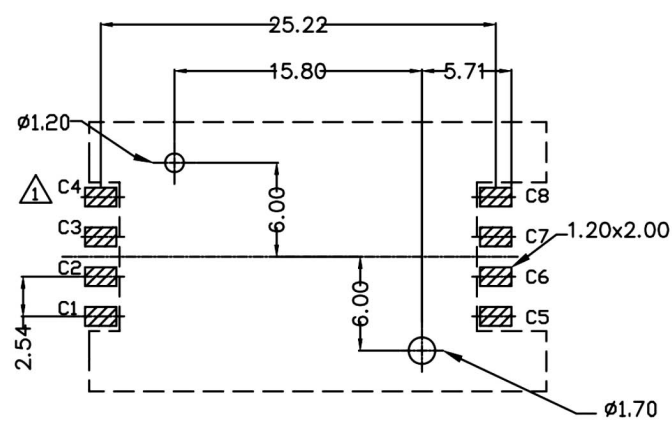
Manual Soldering: 360°C, 3 Sec. Max.

Vapor Phase: 215°C, 30 Sec. Max.

IR Reflow: 260°C, 15 Sec. Max.

Operation Temperature: -25°C To +85°C

RoHS compliant



(.XX±0.05)
REFERENCE PCB LAYOUT

APPD. 核准 HELEN			TOLERANCE 容許公差		PART NAME 品名 SIM CARD BLOCK TYPE HINGED COVER 8P H:2.5mm SELECTIVE GOLD SMT 90° WITH LOCATING PEG,WITHOUT SWITCH ROW P=25.22 BLACK INSULATOR ROHS
DWG. 製圖 ABBY			SCALE 比例 參考		
DATE 制表日 2014/08/08		UNIT 單位 MM		PART NO. 料號 C0612-08DBSB0RR	
		PAGE 張數 1 OF 2		REV. 版次 A	

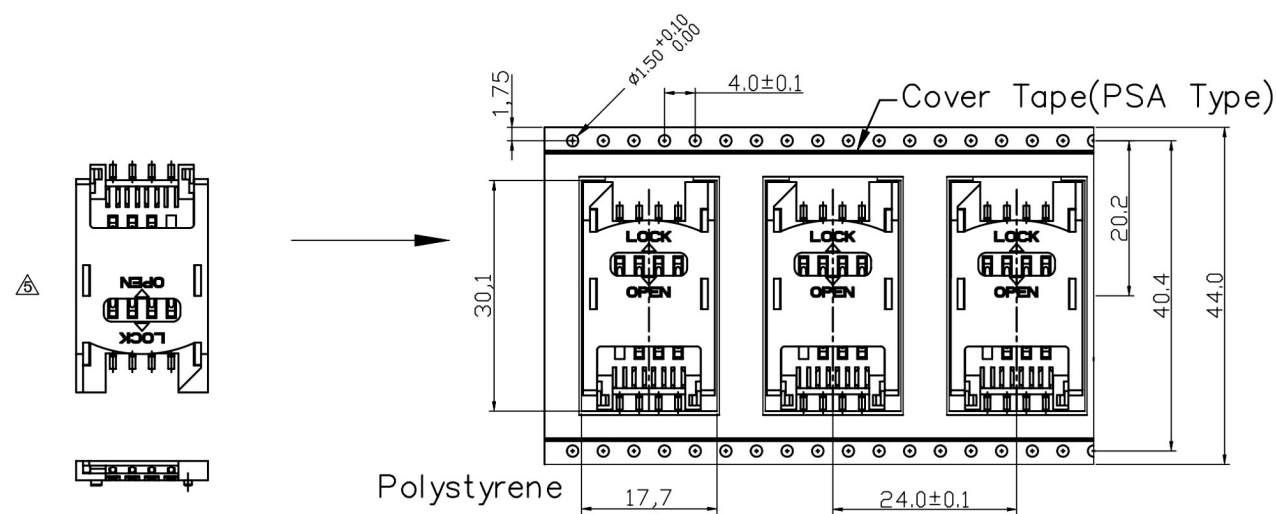
RoHS Compliant

HSM 玄茂科技股份有限公司
HSUAN MAO TECHNOLOGY CO., LTD.

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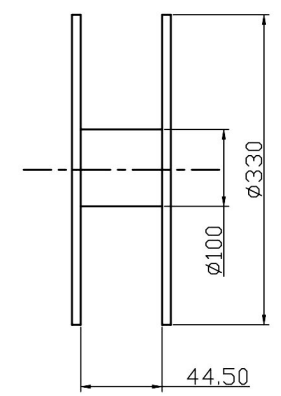
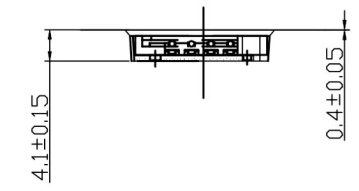
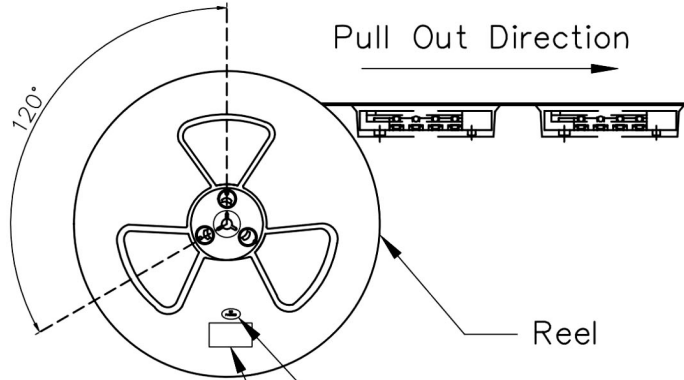
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SPECIFICATIONS:
 Reel Size: 330*44.5 mm
 QTY: 650Pcs/Reel
 RoHS Compliant

Packing Material Description

Polystyrene



RoHS Compliant		玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准 HELEN	SCALE 比例 参考	TOLERANCE 容許公差 .X ±0.20 .XX ±0.10 ANG. ±1°	PART NAME 品名 SIM CARD BLOCK TYPE HINGED COVER 8P H:2.5mm SELECTIVE GOLD SMT 90° WITH LOCATING PEG,WITHOUT SWITCH ROW P=25.22 BLACK INSULATOR ROHS
DWG. 製圖 ABBY		UNIT 單位 MM	SIZE. 紙張尺寸 A 4
DATE 制表日 2014/08/08	PAGE 張數 2 OF 2	REV. 版次 A	

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